## GENERAL DESCRIPTION

The 83948I-01 is a low skew, 1-to-12 Differential-to-LVCMOS Fanout Buffer. The 83948I-01 has two selectable clock inputs. The CLK, nCLK pair can accept most standard differential input levels. The LVCMOS_CLK can accept LVCMOS or LVTTL input levels. The low impedance LVCMOS outputs are designed to drive 50Ω series or parallel terminated transmission lines. The effective fanout can be increased from 12 to 24 by utilizing the ability of the outputs to drive two series terminated lines.

The 83948I-01 is characterized at 3.3V core/3.3V output. Guaranteed output and part-to-part skew characteristics make the 83948I-01 ideal for those clock distribution applications demanding well defined performance and repeatability.

FEATURES

- Twelve LVCMOS outputs

- Selectable LVCMOS clock or differential CLK, nCLK inputs

- CLK, nCLK pair can accept the following differential input levels: LVDS, LVPECL, LVHSTL, SSTL, HCSL

- LVCMOS_CLK accepts the following input levels: LVCMOS or LVTTL

- Maximum output frequency: 150MHz

- Output skew: 350ps (maximum)

- Part to part skew: 1.5ns (maximum)

- 3.3V core, 3.3V output

- -40°C to 85°C ambient operating temperature

- Available in lead-free (RoHS 6) package

BLOCK DIAGRAM
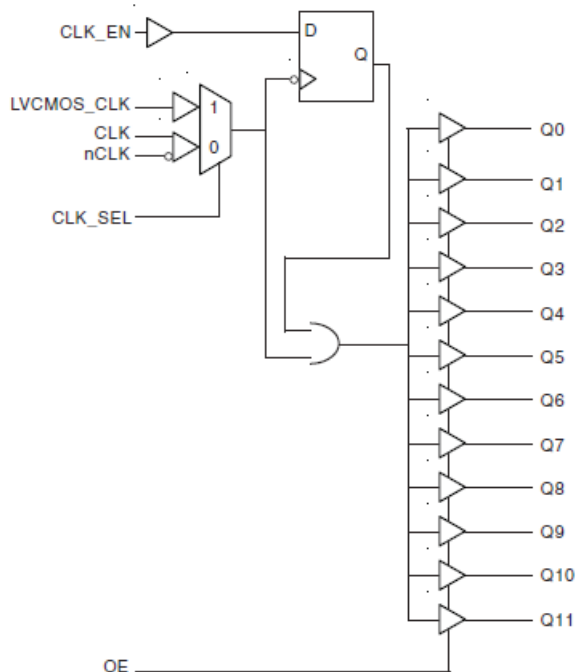
PIN ASSIGNMENT
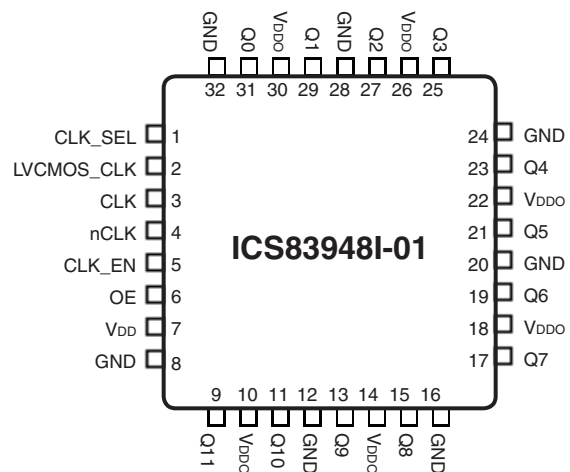
32-Lead LQFP
7mm x 7mm x 1.4mm package body
Y Package
Top View

TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1	CLK_SEL	Input	Pullup	Clock select input. Selects LVCMOS clock input when HIGH. Selects CLK, nCLK inputs when LOW. LVCMOS / LVTTL interface levels.
2	LVCMOS_CLK	Input	Pullup	Clock input. LVCMOS / LVTTL interface levels.
3	CLK	Input	Pullup	Non-inverting differential clock input.
4	nCLK	Input	Pulldown	Inverting differential clock input.
5	CLK_EN	Input	Pullup	Clock enable. LVCMOS / LVTTL interface levels.
6	OE	Input	Pullup	Output enable. LVCMOS / LVTTL interface levels.
7	V_{DD}	Power		Core supply pin.
8, 12, 16, 20, 24, 28, 32	GND	Power		Power supply ground.
9, 11, 13, 15, 17, 19, 21, 23 25, 27, 29, 31	Q11, Q10, Q9, Q8, Q7, Q6, Q5, Q4, Q3, Q2, Q1, Q0	Output		Clock outputs. LVCMOS / LVTTL interface levels.
10, 14, 18, 22, 26, 30	V_{DDO}	Power		Output supply pins.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance				4	pF
C_{PD}	Power Dissipation Capacitance (per output)			25		pF
R_{PULLUP}	Input Pullup Resistor			51		$K\Omega$
$R_{PULLDOWN}$	Input Pulldown Resistor			51		$K\Omega$
R_{OUT}	Output Impedance			7		Ω

TABLE 3A. CLOCK SELECT FUNCTION TABLE

Control Input	Clock	
CLK_SEL	CLK, nCLK	LVCMOS_CLK
0	Selected	De-selected
1	De-selected	Selected

TABLE 3B. CLOCK INPUT FUNCTION TABLE

Inputs				Outputs	Input to Output Mode	Polarity
CLK_SEL	LVCMOS_CLK	CLK	nCLK	Q0:Q12		
0	—	0	1	LOW	Differential to Single Ended	Non Inverting
0	—	1	0	HIGH	Differential to Single Ended	Non Inverting
0	—	0	Biased; NOTE 1	LOW	Single Ended to Single Ended	Non Inverting
0	—	1	Biased; NOTE 1	HIGH	Single Ended to Single Ended	Non Inverting
0	—	Biased; NOTE 1	0	HIGH	Single Ended to Single Ended	Inverting
0	—	Biased; NOTE 1	1	LOW	Single Ended to Single Ended	Inverting
1	0	—	—	LOW	Single Ended to Single Ended	Non Inverting
1	1	—	—	HIGH	Single Ended to Single Ended	Non Inverting

NOTE 1: Please refer to the Application Information section, "Wiring the Differential Input to Accept Single Ended Levels".

Revision A March 18, 2016

Absolute Maximum Ratings

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to V_{DD} + 0.5 V
Outputs, V_O	-0.5V to V_{DDO} + 0.5V
Package Thermal Impedance, θ_{JA}	47.9°C/W (0 lfpm)
Storage Temperature, Tstg	-65°C to 150°C

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY CHARACTERISTICS, V_{DD} = V_{DDO} = 3.3V±0.3V, T$_A$ = -40° TO 85°

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Input Supply Voltage		3.0	3.3	3.6	V
V_{DDO}	Output Supply Voltage		3.0	3.3	3.6	V
I_{DD}	Quiescent Supply Current				55	mA

TABLE 4B. DC CHARACTERISTICS, V_{DD} = V_{DDO} = 3.3V±0.3V, T$_A$ = -40° TO 85°

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	LVCMOS/LVTTL		2		3.6	V
V_{IL}	Input Low Voltage	LVCMOS/LVTTL				0.8	V
V_{PP}	Peak-to-Peak Input Voltage	CLK, nCLK		0.15		1.3	V
V_{CMR}	Input Common Mode Voltage; NOTE 1, 2	CLK, nCLK		GND + 0.5		V_{DD} - 0.85	V
I_{IN}	Input Current					±100	µA
V_{OH}	Output High Voltage		I_{OH} = -20mA	2.5			V
V_{OL}	Output Low Voltage		I_{OL} = 20mA			0.4	V

NOTE 1: For single ended applications, the maximum input voltage for CLK, nCLK is V_{DD} + 0.3V.
NOTE 2: Common mode voltage is defined as V_{IH}.

TABLE 5. AC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 0.3V$, $T_A = -40°$ TO $85°$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Maximum Output Frequency			150			MHz
t_{PD}	Propagation Delay	CLK, nCLK; NOTE 1A		2.5		6.5	ns
		LVCMOS_CLK; NOTE 1B		3		5.5	ns
tsk(o)	Output Skew; NOTE 2, 6		Measured on rising edge @$V_{DDO}/2$			350	ps
tsk(pp)	Part-to-Part Skew; NOTE 3, 6	CLK, nCLK	Measured on rising edge @$V_{DDO}/2$			1.5	ns
		LVCMOS_CLK				2	ns
t_R	Output Rise Time		0.8V to 2V	0.2		1.0	ns
t_F	Output Fall Time		0.8V to 2V	0.2		1.0	ns
t_{PW}	Output Pulse Width			tPeriod/2 - 800		tPeriod/2 + 800	ps
t_{PZL}, t_{PZH}	Output Disable Time; NOTE 4					11	ns
t_{PLZ}, t_{PHZ}	Output Enable Time; NOTE 4					11	ns
t_S	Clock Enable Setup Time; NOTE 5	CLK_EN to CLK		1			ns
		CLK_EN to LVCMOS_CLK		0			ns
t_H	Clock Enable Hold Time; NOTE 5	CLK to CLK_EN		0			ns
		LVCMOS_CLK to CLK_EN		1			ns

NOTE 1A: Measured from the differential input crossing point to $V_{DDO}/2$ of the output.
NOTE 1B: Measured from the $V_{DD}/2$ of the input to $V_{DDO}/2$ of the output.
NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDO}/2$.
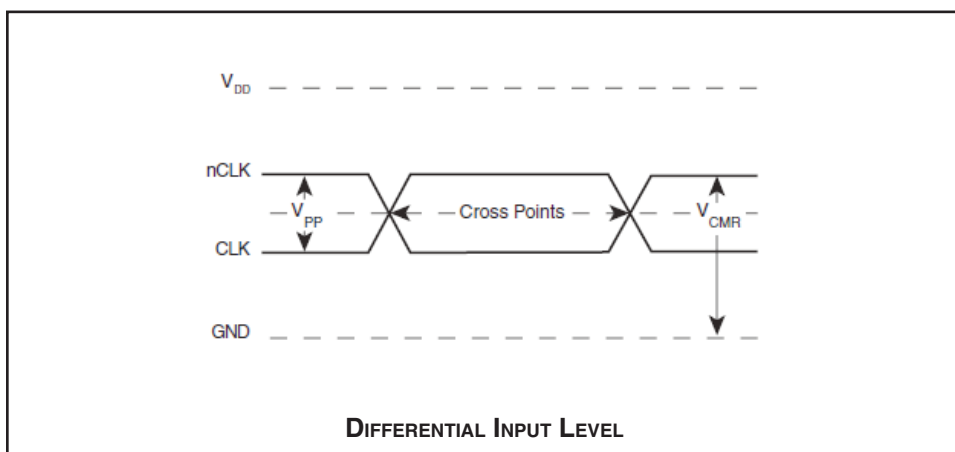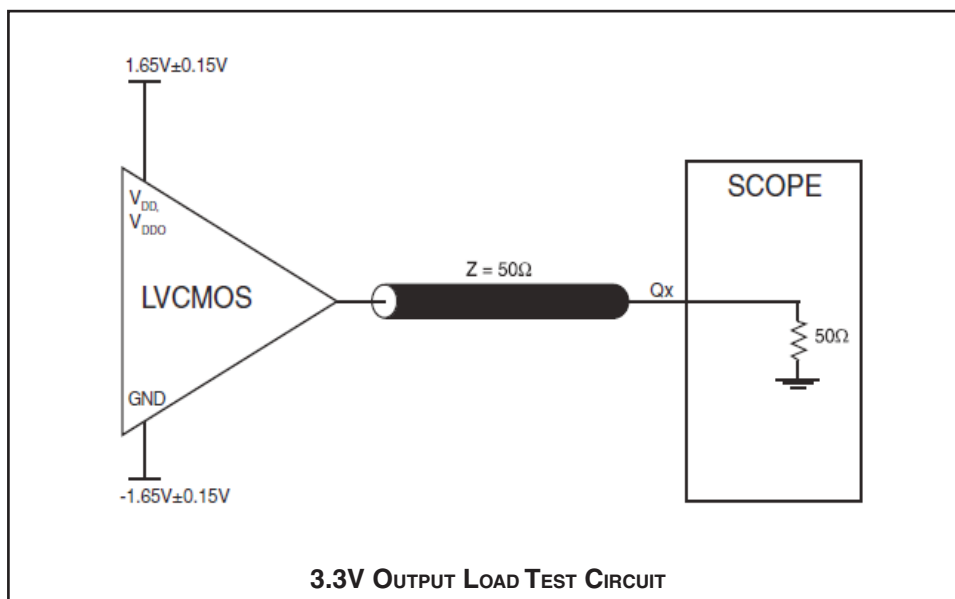NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDO}/2$.
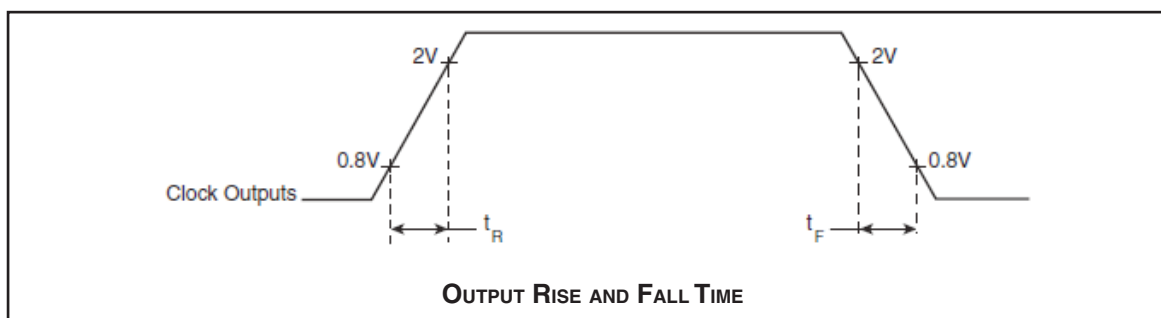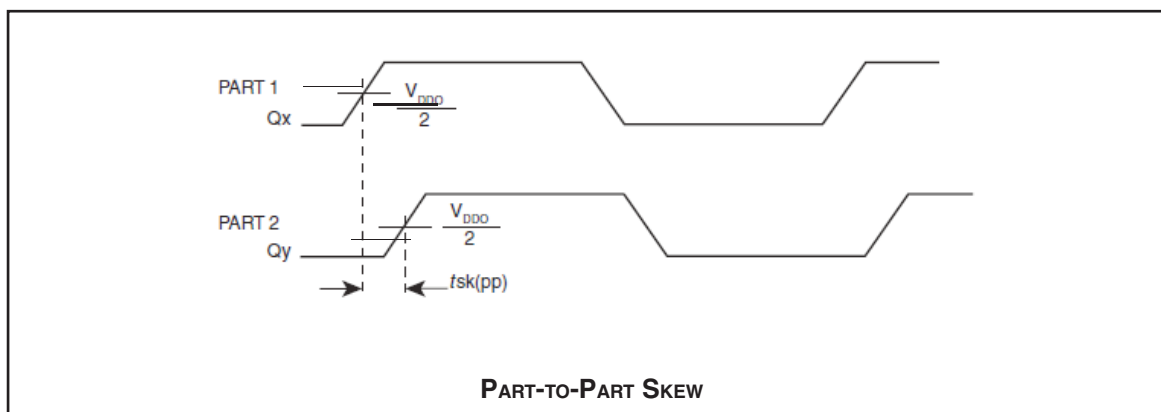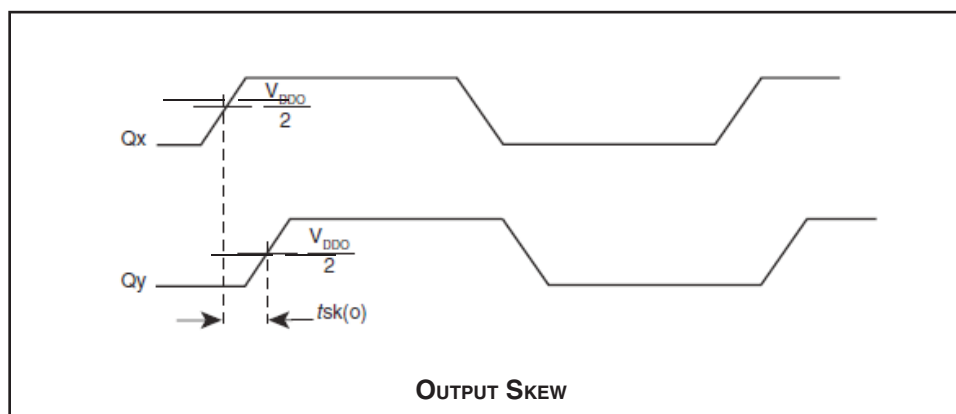NOTE 4: These parameters are guaranteed by characterization. Not tested in production.
NOTE 5: Setup and Hold times are relative to the falling edge of the input clock.
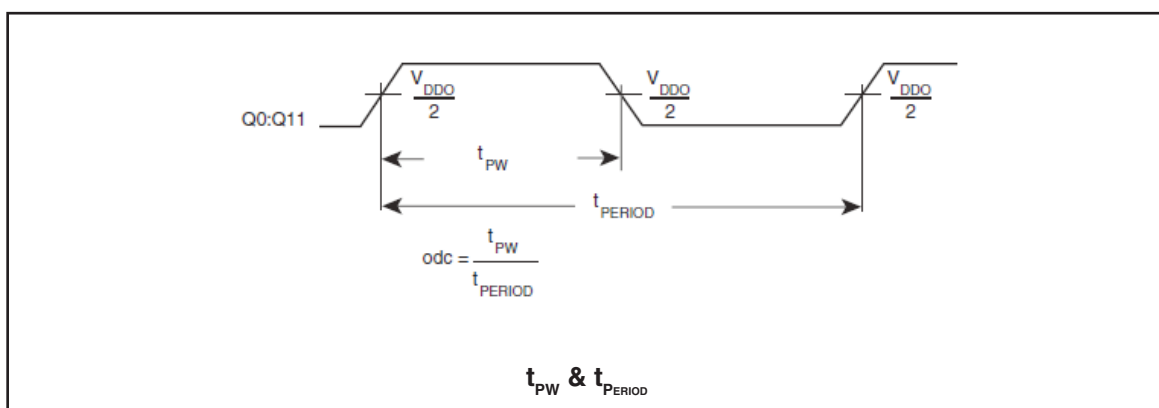NOTE 6: This parameter is defined in accordance with JEDEC Standard 65.
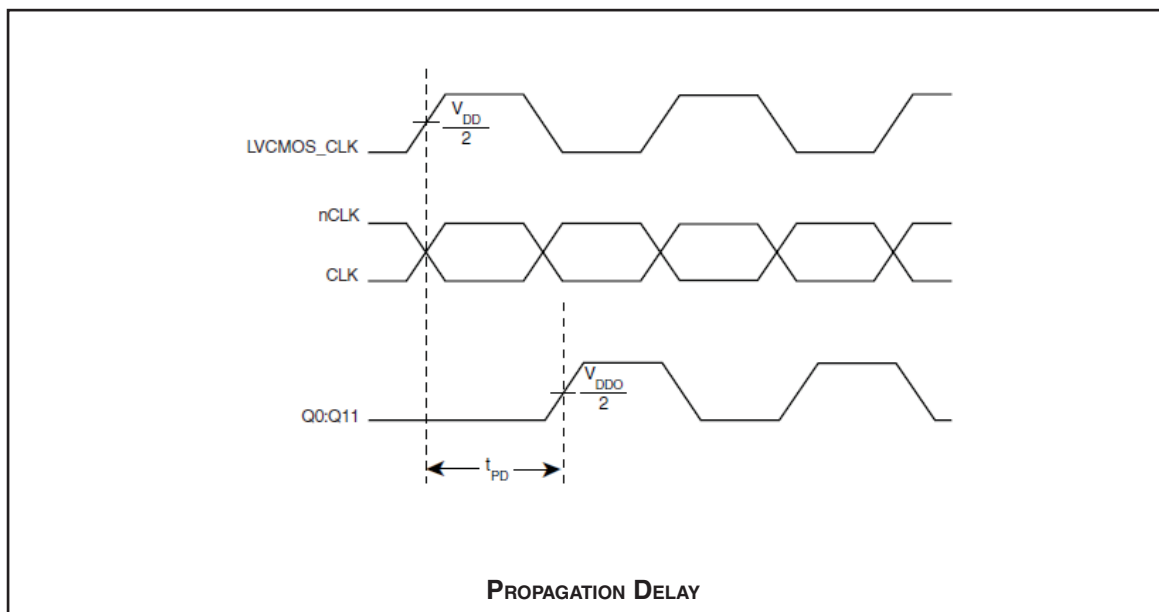
PARAMETER MEASUREMENT INFORMATION

1.65V±0.15V

V_DD, V_DDO

LVCMOS

GND

-1.65V±0.15V

Z = 50Ω

Qx

SCOPE

50Ω

3.3V OUTPUT LOAD TEST CIRCUIT

V_DD

nCLK

V_PP

Cross Points

V_CMR

CLK

GND

DIFFERENTIAL INPUT LEVEL

PARAMETER MEASUREMENT INFORMATION, CONTINUED

OUTPUT SKEW

PART-TO-PART SKEW

OUTPUT RISE AND FALL TIME

PARAMETER MEASUREMENT INFORMATION, CONTINUED

PROPAGATION DELAY

$$odc = \frac{t_{PW}}{t_{PERIOD}}$$

t_{PW} & t_{PERIOD}

APPLICATION INFORMATION

WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 2 shows how the differential input can be wired to accept single ended levels. The reference voltage $V\_REF = V_{DD}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{DD} = 3.3V$, V_REF should be 1.25V and R2/R1 = 0.609.


FIGURE 2 - SINGLE ENDED SIGNAL DRIVING DIFFERENTIAL INPUT
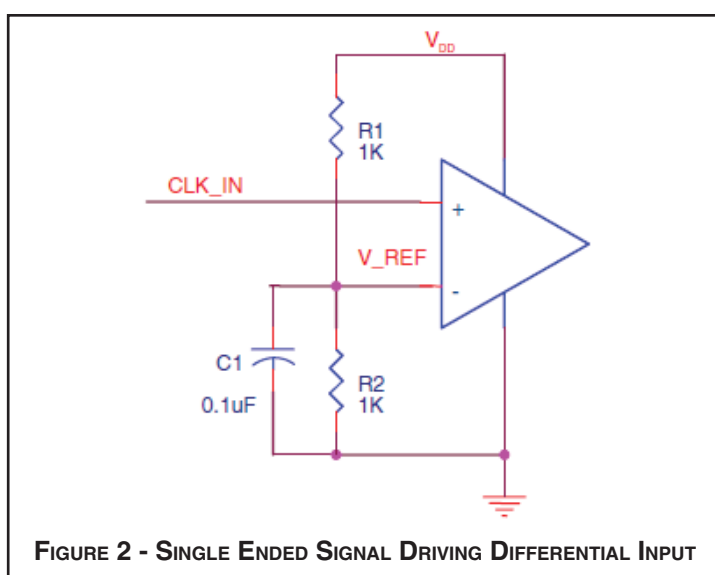
RELIABILITY INFORMATION

TABLE 6. θ_{JA} **VS. AIR FLOW TABLE**

<div style="border:1px solid black">

θ_{JA} by Velocity (Linear Feet per Minute)

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

</div>

TRANSISTOR COUNT

The transistor count for 83948I-01 is: 1040

PACKAGE OUTLINE - Y SUFFIX
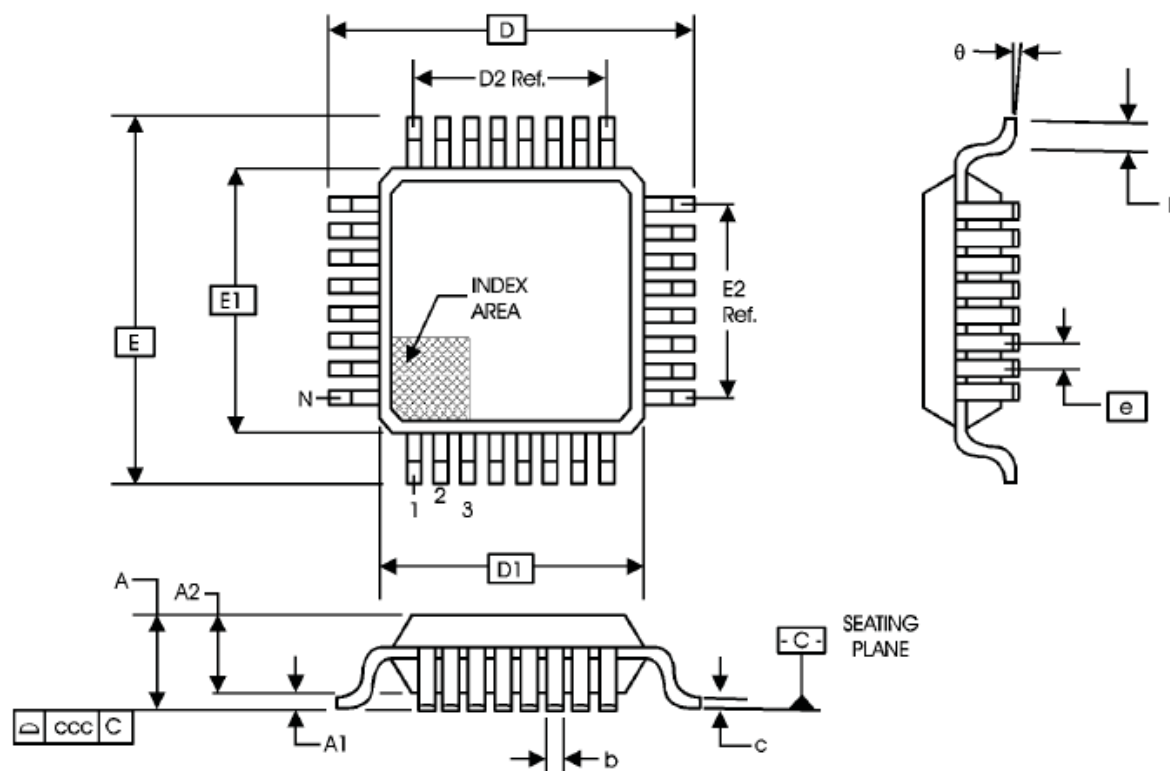
TABLE 7. PACKAGE DIMENSIONS

SYMBOL	JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS		
	BBA		
	MINIMUM	NOMINAL	MAXIMUM
N	32		
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	--	0.20
D	9.00 BASIC		
D1	7.00 BASIC		
D2	5.60 Ref.		
E	9.00 BASIC		
E1	7.00 BASIC		
E2	5.60 Ref.		
e	0.80 BASIC		
L	0.45	0.60	0.75
θ	0°	--	7°
ccc	--	--	0.10

REFERENCE DOCUMENT: JEDEC PUBLICATION 95, MS-026

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Count	Temperature
83948AYI-01LF	ICS3948AI01L	Lead-Free, 32 Lead LQFP	Tray	-40°C to 85°C
83948AYI-01LFT	ICS3948AI01L	Lead-Free, 32 Lead LQFP	Tape & Reel	-40°C to 85°C

REVISION HISTORY SHEET

Rev	Table	Page	Description of Change	Date
A	T8	11 13	Updated datasheet's header/footer with IDT from ICS. Ordering Information Table - removed ICS prefix from Part/Order Number column. Added lead-free marking. Added Contact Page.	9/6/11
A	T8	11	Ordering Information - removed leaded devices. Updated data sheet format.	3/27/15
A	T8	11	Ordering Information - Deleted LF note below table. Updated header and footer.	3/18/16

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:
www.renesas.com/contact/